



**Microsemi Corp.**

The diode experts

SCOTTSDALE, AZ  
For more information call:  
(602) 941-6300

**1N759A, -1  
and  
1N4370 thru  
1N4372A, -1  
DO-35**

1% and 2% VERSIONS  
"C" and "D" AVAILABLE

**FEATURES**

- ZENER VOLTAGE 2.4V to 12.0V
- AVAILABLE IN JAN, JANTX AND JANTXV-1 QUALIFICATIONS TO MIL-S-19500/127. DIE ALSO AVAILABLE AS JANHC FOR HYBRIDS.
- METALLURGICALLY BONDED DEVICE TYPES

**MAXIMUM RATINGS**

Junction and Storage Temperatures: -65°C to +175°C  
DC Power Dissipation: 500 mW  
Power Derating: 4.0 mW/°C above 50°C  
Forward Voltage @ 200 mA: 1.5 Volts

**\* ELECTRICAL CHARACTERISTICS @ 25°C**

JEDEC TYPE NO. (NOTE 1)	NOMINAL ZENER VOLTAGE $V_Z @ I_{ZT}$ (NOTE 2)	ZENER TEST CURRENT $I_{ZT}$	MAXIMUM ZENER IMPEDANCE $Z_{ZT} @ I_{ZT}$ (NOTE 3)	MAXIMUM REVERSE CURRENT @ $V_R = 1$ VOLT		MAXIMUM ZENER CURRENT $I_{ZM}$ (NOTE 4)	TYPICAL TEMP COEFF OF ZENER VOLTAGE $\frac{\Delta V_Z}{\Delta T}$
				@ 25°C	@ +150°C		
				μA	μA		
	VOLTS	mA	OHMS	μA	μA	mA	%/°C
1N4370	2.4	20	30	100	200	150	-0.085
1N4371	2.7	20	30	75	150	135	-0.080
1N4372	3.0	20	29	50	100	120	-0.075
1N746	3.3	20	28	10	30	110	-0.066
1N747	3.6	20	24	10	30	100	-0.058
1N748	3.9	20	23	10	30	95	-0.046
1N749	4.3	20	22	2	30	85	-0.033
1N750	4.7	20	19	2	30	75	-0.015
1N751	5.1	20	17	1	20	70	±0.010
1N752	5.6	20	11	1	20	65	+0.030
1N753	6.2	20	7	.1	20	60	+0.049
1N754	6.8	20	5	.1	20	55	+0.053
1N755	7.5	20	6	.1	20	50	+0.057
1N756	8.2	20	8	.1	20	45	+0.060
1N757	9.1	20	10	.1	20	40	+0.061
1N758	10.0	20	17	.1	20	35	+0.062
1N759	12.0	20	30	.1	20	30	+0.062

JEDEC Registered Data

**NOTE 1** Standard tolerance on JEDEC types shown is ±10%. Suffix letter A denotes ±5% tolerance; suffix letter C denotes ±2%; and suffix letter D denotes ±1% tolerance.

**NOTE 2** Voltage measurements to be performed 20 sec. after application of D.C. test current.

**NOTE 3** Zener impedance derived by superimposing on  $I_{ZT}$ , a 60 cps, rms ac current equal to 10%  $I_{ZT}$  (2 mA ac).

**NOTE 4** Allowance has been made for the increase in  $V_Z$  due to  $Z_Z$  and for the increase in junction temperature as the unit approaches thermal equilibrium at the power dissipation of 400 mW.

**SILICON  
500 mW  
ZENER DIODES**

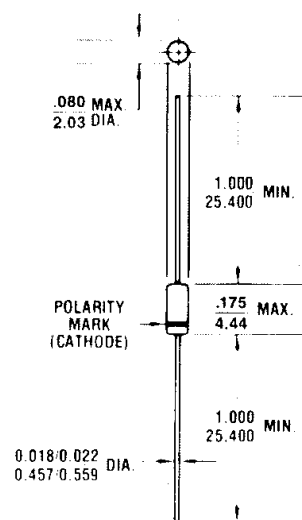


FIGURE 1

All dimensions in INCH  
m.m.

**MECHANICAL CHARACTERISTICS**

CASE: Hermetically sealed glass case. DO-35.

FINISH: All external surfaces are corrosion resistant and leads solderable.

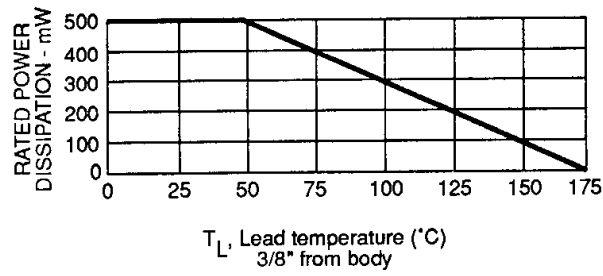
THERMAL RESISTANCE: 200°C/W (Typical) junction to lead at 0.375-inches from body. Metallurgically bonded DO-35's exhibit less than 100 °C/W at zero distance from body.

POLARITY: Diode to be operated with the banded end positive with respect to the opposite end.

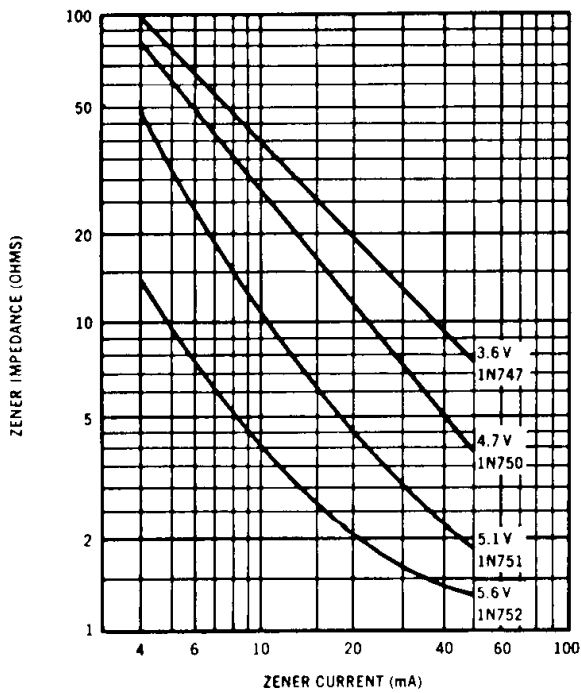
WEIGHT: 0.2 grams.

MOUNTING POSITIONS: Any.

**1N746 thru 1N759A, -1 DO-35**  
**1N4370 thru 1N4372A, -1**

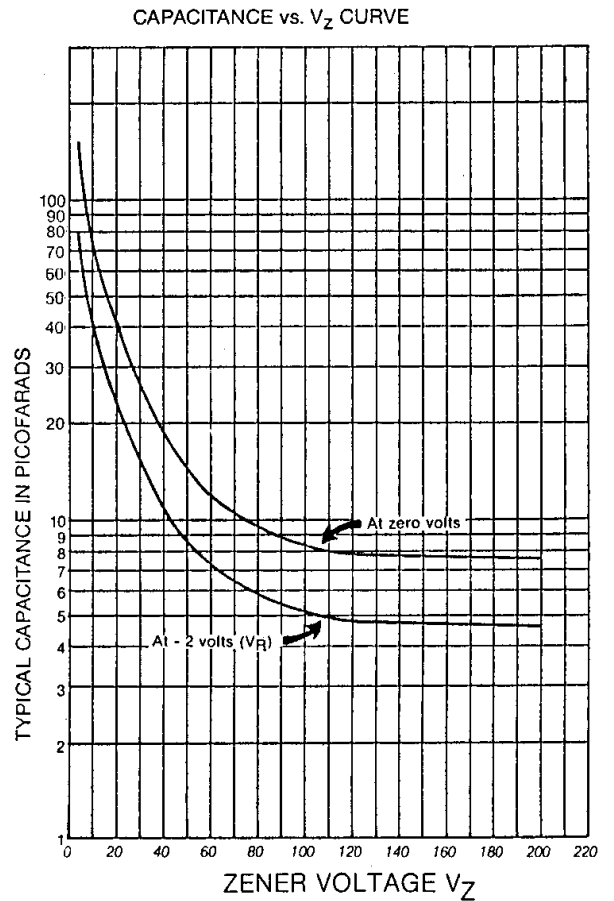


**FIGURE 2** POWER DERATING CURVE



**FIGURE 3**

ZENER IMPEDANCE VS ZENER CURRENT (TYPICAL)



**FIGURE 4**

CAPACITANCE VS. ZENER VOLTAGE (TYPICAL)